



RECOMMENDED LAND PATTERN DIMENSION OF PCB
(RECOMMENDED METAL MASK THICKNESS:0.15mm)

- NOTE
- 1. SMT LEAD-COPLANARITY:0.1 MAX.
 - 2. THIS PRODUCT HAS NO POLARITY TO PATTERN FOR MOUNTING.
 - 3. MAKE SURE WIDTH OF PATTERN IS WITHIN THAT OF LAND, OR LEAD MAY TOUCH PATTERN. (THIS APPLIES TO HATCHED AREA.)
 - 4. STACKING HEIGHT FROM LEAD TO LEAD.
 - 5. BOARD DISTANCE

2	COPPER ARROY	CONTACT : GOLD PLATING 0.76µm MIN LEAD : GOLD PLATING 0.03µm MIN UNDER :NICKEL PLATING 1.3µm MIN	3	COPPER ARROY	LEAD : GOLD PLATING 0.03µm MIN UNDER :NICKEL PLATING 1.3µm MIN
1	LCP	BEIGE, UL94V-0			
NO.	MATERIAL	FINISH . REMARKS	NO.	MATERIAL	FINISH . REMARKS
UNITS		SCALE	COUNT	DESCRIPTION OF REVISIONS	
mm		4:1	△	DESIGNED	CHECKED
HRS HIROSE ELECTRIC CO., LTD.		APPROVED :NH. NAKATA	16.11.10	DRAWING NO. EDC-151959-93-00	
		CHECKED :HT. YAMAGUCHI	16.11.10	PART NO. FX10B-168P-SV(93)	
		DESIGNED :MT. ITANO	16.11.10	CODE NO. CL570-0054-1-93	
		DRAWN :MT. ITANO	16.11.10	1/1	